## PATENT ASSIGNMENT

**Electronic Version v1.1**  
**Stylesheet Version v1.1**

### SUBMISSION TYPE: NEW ASSIGNMENT

### NATURE OF CONVEYANCE: ASSIGNMENT

### CONVEYING PARTY DATA

<table>
<thead>
<tr>
<th>Name</th>
<th>Execution Date</th>
</tr>
</thead>
<tbody>
<tr>
<td>Katsuhiko Tomoda</td>
<td>06/25/2007</td>
</tr>
<tr>
<td>Shiyuki Kanisawa</td>
<td>06/21/2007</td>
</tr>
<tr>
<td>Hidetsugu Namiki</td>
<td>06/21/2007</td>
</tr>
</tbody>
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### RECEIVING PARTY DATA

<table>
<thead>
<tr>
<th>Name</th>
<th>Address</th>
</tr>
</thead>
<tbody>
<tr>
<td>Sony Corporation</td>
<td>1-7-1 Konan, Minato-ku</td>
</tr>
<tr>
<td>Sony Chemical &amp; Information Device Corporation</td>
<td>1-11-2, Osaki, Shinagawa-ku</td>
</tr>
<tr>
<td>CoMersity, Inc.</td>
<td>1101, 1020, Hailey Ave.</td>
</tr>
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### PROPERTY NUMBERS Total: 1

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<tr>
<th>Property Type</th>
<th>Number</th>
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<tr>
<td>Application Number</td>
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### CORRESPONDENCE DATA

- **Fax Number:** (312)827-8185
- **Email:** patents@bellboyd.com
- **Correspondent Name:** Thomas C. Basso
- **Address Line 1:** Bell, Boyd & Lloyd LLP, P.O. Box 1135
- **Address Line 2:** Chicago, ILLINOIS 60690-1135

### ATTORNEY DOCKET NUMBER: 113380-007

### NAME OF SUBMITTER: Thomas C. Basso
ASSIGNMENT

WHEREAS, the undersigned, to wit: Katsuhiro Tomoda, Shiyuki Kanisawa and Hidetsugu Namiki (hereinafter "ASSIGNS"), are the lawful owners of an invention entitled: DEVICE, METHOD OF MANUFACTURING DEVICE, BOARD, METHOD OF MANUFACTURING BOARD, MOUNTING STRUCTURE, MOUNTING METHOD, LED DISPLAY, LED BACKLIGHT AND ELECTRONIC DEVICE, for which a patent application of the United States will be filed in the United States Patent and Trademark Office or was filed on July 17, 2007 in the United States Patent and Trademark Office having Application Serial No. 11/778,736 ;

AND WHEREAS, Sony Corporation, a corporation duly organized and existing under the laws of Japan and having its principal office and place of business at 1-7-1 Konan, Minato-ku, Tokyo, 108-0075 Japan, and Sony Chemical & Information Device Corporation, a corporation duly organized and existing under the laws of Japan and having its principal office and place of business at 1-11-2, Osaki, Shinagawa-ku, Tokyo, Japan (hereinafter "ASSIGNEES") desires to acquire the entire right, title, and interest therein;

NOW, THEREFORE, in consideration of One Dollar ($1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, said ASSIGNS do hereby sell, assign, and transfer, and hereby set over unto ASSIGNEES, its successors, assigns and legal representatives, the full and exclusive right, title and interest to said invention in the United States of America and all foreign countries, including, without limitation, said invention as described in the aforesaid application, to be held and enjoyed by said ASSIGNEES, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by said ASSIGNS had this assignment and sale not been made, including, without limitation, all rights to the aforesaid application and to any United States Letters Patent therefor, when issued together with all improvements thereon and betterments thereof, all related applications including, but not limited to, divisions, continuations, continuations-in-part, reissues and reexaminations thereof and substitutions of or for said application, and all foreign rights including the right to make application for Letters Patent for said inventions in any and all foreign countries and the right to claim priority as to the filing date under the International Convention on the basis for the aforesaid application for United States Letters Patent; and ASSIGNS hereby authorize and request the Commissioner of Patents to issue all Letters Patent issuing therefrom to ASSIGNEES, for its interest as ASSIGNEES, its successors, assigns and legal representatives.

ASSIGNS hereby agree to execute any papers, provide any information and testify in any interference or litigation at the request of ASSIGNEES, its successors, assigns and legal representatives, when deemed essential to ASSIGNEES’, its successors', assigns' and legal representatives' full enjoyment, protection, enforcement and title in and to such invention and rights hereby transferred.

ASSIGNS furthermore agree upon request of said ASSIGNEES, its successors, assigns and legal representatives, and without further remuneration, to execute any and all papers desired by said ASSIGNEES, its successors, assigns and legal representatives, for the filing and
granting of foreign applications and the perfecting of title thereto in said ASSIGNEES, its successors, assigns and legal representatives.

It is hereby authorized that the attorney of record in the above-referenced patent application insert the serial number and filing date of the patent application, if applicable, in the spaces identified above.
Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Date Signed

Kazuko Fujio

June 25, 2007
Signature

Kanisawa

Name: Shiyuki Kanisawa

Address: c/o Sony Chemical & Information Device Corporation
1-11-2, Osaki, Shinagawa-ku
Tokyo, Japan

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Marugame

Date Signed

2007.6.2

Date Signed

Jun. 21, 2007
Signature

Hidetsugu Namiki

Name: Hidetsugu Namiki

Address: c/o Sony Chemical & Information Device Corporation
1-11-2, Osaki, Shinagawa-ku
Tokyo, Japan

Date Signed

2007.6.2

Before me personally appeared the person whose name is subscribed to the foregoing instrument, and executed the foregoing instrument in my presence for the purpose contained therein, by signing his/her name hereto.

Signature

Takeshi Murayama

Date Signed

Jun. 21, 2007